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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	I ² C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	37
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f562t7edfk-v3

1.4 Pin Assignments

Figure 1.3 to Figure 1.7 show the pins assignments. Table 1.4 to Table 1.8 show the list of pins and pin functions.

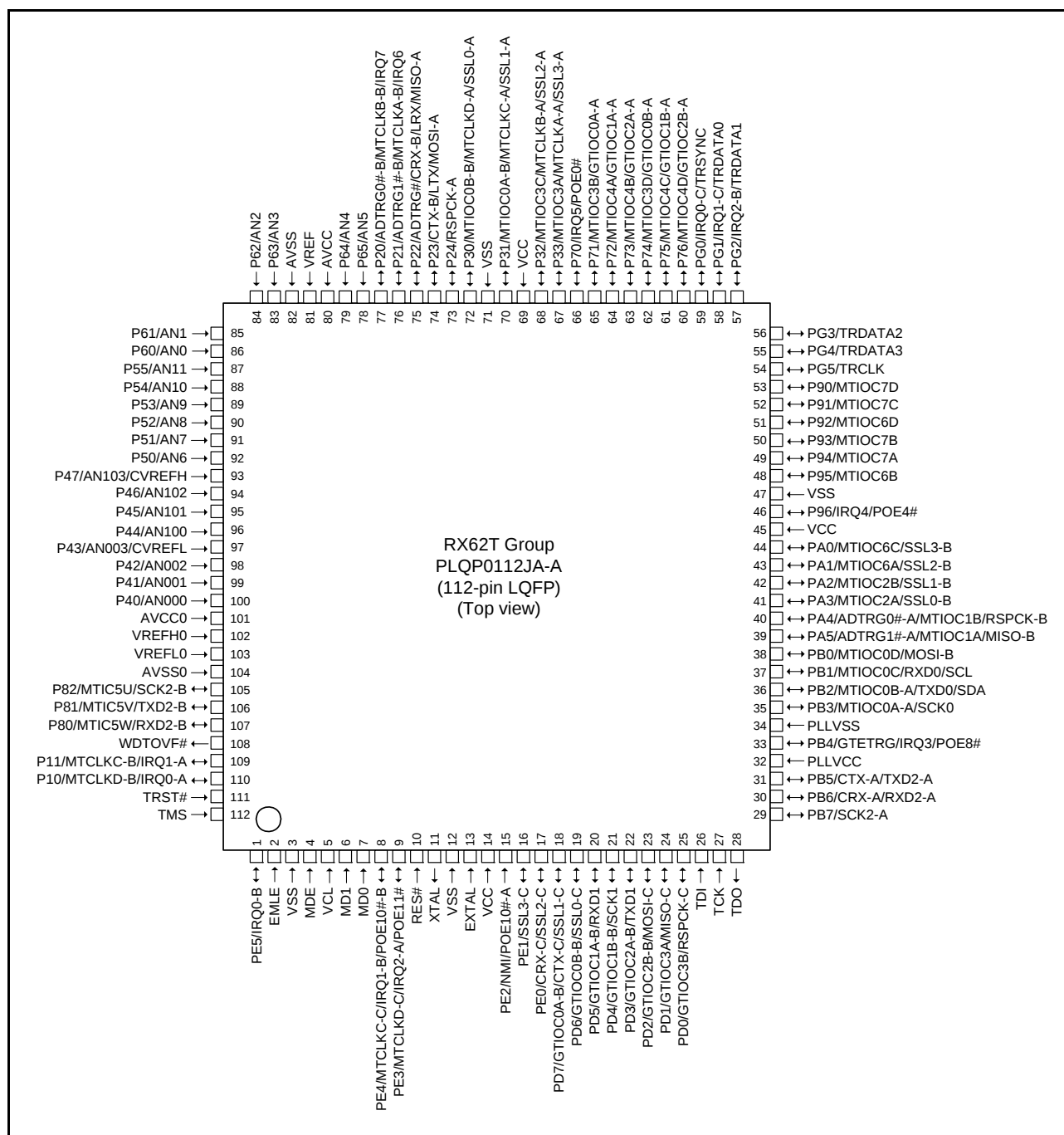


Figure 1.3 Pin Assignment of the 112-Pin LQFP

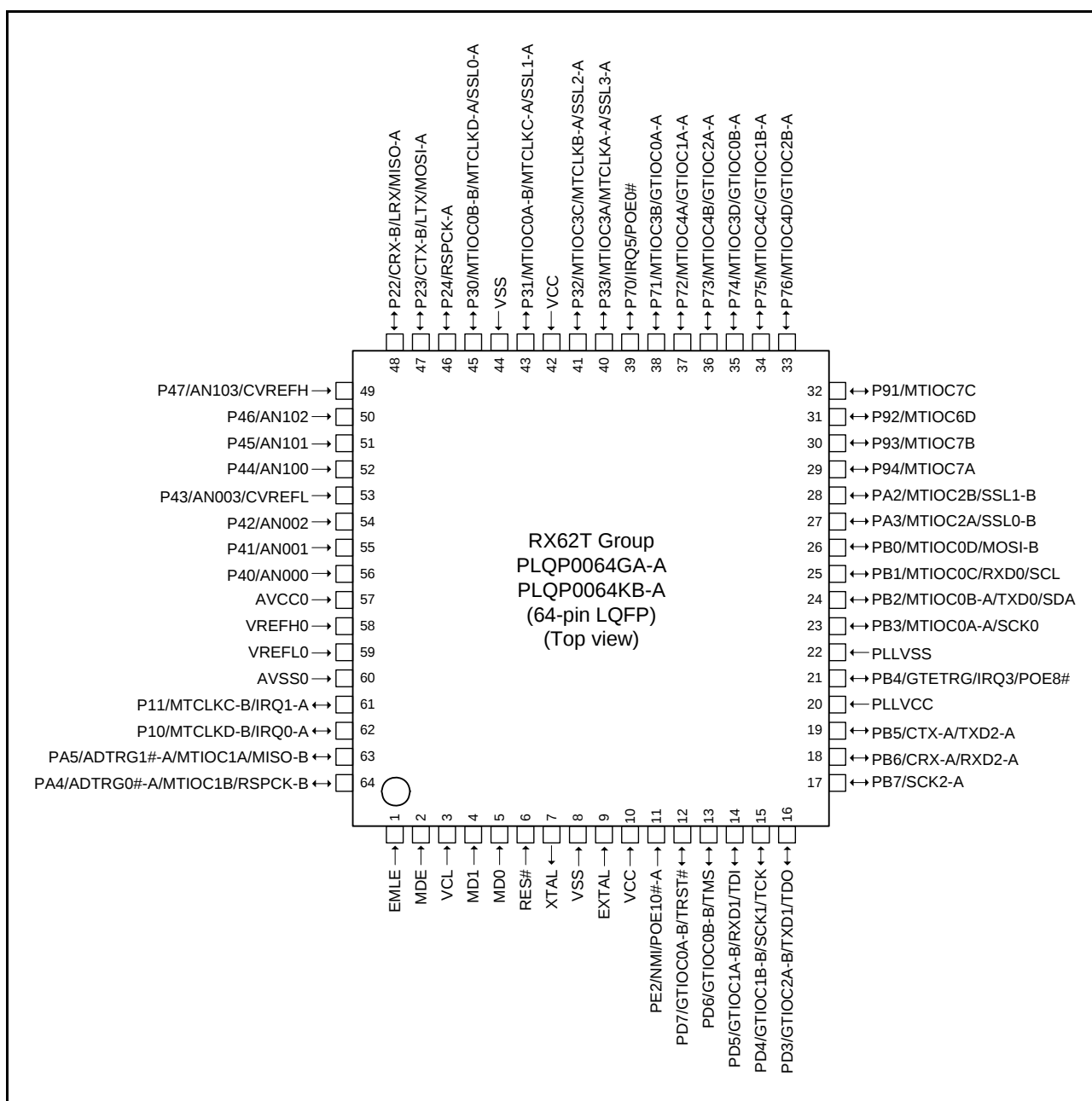


Figure 1.7 Pin Assignment of the 64-Pin LQFP

Table 1.4 List of Pins and Pin Functions (112-Pin LQFP) (1 / 3)

Pin No. (112-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi- cation	Interrupt	POE	Debugging
1		PE5				IRQ0-B		
2	EMLE							
3	VSS							
4	MDE							
5	VCL							
6	MD1							
7	MD0							
8		PE4		MTCLKC-C		IRQ1-B	POE10#-B	
9		PE3		MTCLKD-C		IRQ2-A	POE11#	
10	RES#							
11	XTAL							
12	VSS							
13	EXTAL							
14	VCC							
15		PE2				NMI	POE10#-A	
16		PE1			SSL3-C			
17		PE0			CRX-C/ SSL2-C			
18		PD7		GTIOC0A-B	CTX-C/ SSL1-C			
19		PD6		GTIOC0B-B	SSL0-C			
20		PD5		GTIOC1A-B	RXD1			
21		PD4		GTIOC1B-B	SCK1			
22		PD3		GTIOC2A-B	TXD1			
23		PD2		GTIOC2B-B	MOSI-C			
24		PD1		GTIOC3A	MISO-C			
25		PD0		GTIOC3B	RSPCK-C			
26								TDI
27								TCK
28								TDO
29		PB7			SCK2-A			
30		PB6			CRX-A/ RXD2-A			
31		PB5			CTX-A/ TXD2-A			
32	PLLVCC							
33		PB4		GTETRG		IRQ3	POE8#	
34	PLLVSS							
35		PB3		MTIOC0A-A	SCK0			
36		PB2		MTIOC0B-A	TXD0/SDA			
37		PB1		MTIOC0C	RXD0/SCL			
38		PB0		MTIOC0D	MOSI-B			
39		PA5	ADTRG1#-A	MTIOC1A	MISO-B			
40		PA4	ADTRG0#-A	MTIOC1B	RSPCK-B			
41		PA3		MTIOC2A	SSL0-B			
42		PA2		MTIOC2B	SSL1-B			
43		PA1		MTIOC6A	SSL2-B			

Table 1.5 List of Pins and Pin Functions (100-Pin LQFP) (1 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi- cation	Interrupt	POE	Debugging
1		PE5				IRQ0-B		
2	EMLE							
3	VSS							
4	MDE							
5	VCL							
6	MD1							
7	MD0							
8		PE4		MTCLKC-C		IRQ1-B	POE10#-B	
9		PE3		MTCLKD-C		IRQ2-A	POE11#	
10	RES#							
11	XTAL							
12	VSS							
13	EXTAL							
14	VCC							
15		PE2				NMI	POE10#-A	
16		PE1			SSL3-C			
17		PE0			CRX-C/ SSL2-C			
18		PD7		GTIOC0A-B	CTX-C/SSL1-C			TRST#
19		PD6		GTIOC0B-B	SSL0-C			TMS
20		PD5		GTIOC1A-B	RXD1			TDI
21		PD4		GTIOC1B-B	SCK1			TCK
22		PD3		GTIOC2A-B	TXD1			TDO
23		PD2		GTIOC2B-B	MOSI-C			TRCLK
24		PD1		GTIOC3A	MISO-C			TRDATA3
25		PD0		GTIOC3B	RSPCK-C			TRDATA2
26		PB7			SCK2-A			TRDATA1
27		PB6			CRX-A/ RXD2-A			TRDATA0
28		PB5			CTX-A/TXD2-A			TRSYNC
29	PLLVC							
30		PB4		GTETR		IRQ3	POE8#	
31	PLLVS							
32		PB3		MTIOC0A-A	SCK0			
33		PB2		MTIOC0B-A	TXD0/SDA			
34		PB1		MTIOC0C	RXD0/SCL			
35		PB0		MTIOC0D	MOSI-B			
36		PA5	ADTRG1#-A	MTIOC1A	MISO-B			
37		PA4	ADTRG0#-A	MTIOC1B	RSPCK-B			
38		PA3		MTIOC2A	SSL0-B			
39		PA2		MTIOC2B	SSL1-B			
40		PA1		MTIOC6A	SSL2-B			

Table 1.8 List of Pins and Pin Functions (64-Pin LQFP) (2 / 2)

Pin No. (64-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi- cation	Interrupt	POE	Debuggi ng
40		P33		MTIOC3A/ MTCLKA-A	SSL3-A			
41		P32		MTIOC3C/ MTCLKB-A	SSL2-A			
42	VCC							
43		P31		MTIOC0A-B/ MTCLKC-A	SSL1-A			
44	VSS							
45		P30		MTIOC0B-B/ MTCLKD-A	SSL0-A			
46		P24			RSPCK-A			
47		P23			CTX-B/ LTX/ MOSI-A			
48		P22			CRX-B/ LRX/ MISO-A			
49		P47	AN103/ CVREFH					
50		P46	AN102					
51		P45	AN101					
52		P44	AN100					
53		P43	AN003/ CVREFL					
54		P42	AN002					
55		P41	AN001					
56		P40	AN000					
57	AVCC0							
58	VREFH0							
59	VREFL0							
60	AVSS0							
61		P11		MTCLKC-B		IRQ1-A		
62		P10		MTCLKD-B		IRQ0-A		
63		PA5	ADTRG1#-A	MTIOC1A	MISO-B			
64		PA4	ADTRG0#-A	MTIOC1B	RSPCK-B			

(4) Number of Access Cycles to I/O Registers

The number of access cycles to I/O registers is obtained by following equation.*

$$\begin{aligned} \text{Number of access cycles to I/O registers} = & \text{Number of bus cycles for internal main bus 1} + \\ & \text{Number of divided cycles for clock synchronization} + \\ & \text{Number of bus cycles for internal peripheral buses 1, 2, 4, and 6} \end{aligned}$$

The number of bus cycles for internal peripheral buses 1, 2, 4, and 6 differs according to the register to be accessed. For the number of access cycles to each I/O register, see Table 4.1, List of I/O Registers.

When peripheral functions connected to internal peripheral bus 6 are accessed, the number of divided cycles for clock synchronization is added.

Although the number of divided cycles for clock synchronization differs depending on the number of frequency ratio between ICLK and PCLK or bus access timing, the sum of the number of bus cycles for internal main bus 1 and the number of divided cycles for clock synchronization will be one PCLK at a maximum. Therefore, one PCLK is added to the number of access cycles shown in Table 4.1.

Note: • This applies to the number of cycles when the access from the CPU does not conflict with the instruction fetching to the external memory or bus access from the different bus master (DTC).

Table 4.2 List of I/O Registers (Bit Order) (6 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
ICU	DTCER029	—	—	—	—	—	—	—	DTCE
ICU	DTCER030	—	—	—	—	—	—	—	DTCE
ICU	DTCER031	—	—	—	—	—	—	—	DTCE
ICU	DTCER045	—	—	—	—	—	—	—	DTCE
ICU	DTCER046	—	—	—	—	—	—	—	DTCE
ICU	DTCER064	—	—	—	—	—	—	—	DTCE
ICU	DTCER065	—	—	—	—	—	—	—	DTCE
ICU	DTCER066	—	—	—	—	—	—	—	DTCE
ICU	DTCER067	—	—	—	—	—	—	—	DTCE
ICU	DTCER068	—	—	—	—	—	—	—	DTCE
ICU	DTCER069	—	—	—	—	—	—	—	DTCE
ICU	DTCER070	—	—	—	—	—	—	—	DTCE
ICU	DTCER071	—	—	—	—	—	—	—	DTCE
ICU	DTCER098	—	—	—	—	—	—	—	DTCE
ICU	DTCER102	—	—	—	—	—	—	—	DTCE
ICU	DTCER103	—	—	—	—	—	—	—	DTCE
ICU	DTCER106	—	—	—	—	—	—	—	DTCE
ICU	DTCER114	—	—	—	—	—	—	—	DTCE
ICU	DTCER115	—	—	—	—	—	—	—	DTCE
ICU	DTCER116	—	—	—	—	—	—	—	DTCE
ICU	DTCER117	—	—	—	—	—	—	—	DTCE
ICU	DTCER121	—	—	—	—	—	—	—	DTCE
ICU	DTCER122	—	—	—	—	—	—	—	DTCE
ICU	DTCER125	—	—	—	—	—	—	—	DTCE
ICU	DTCER126	—	—	—	—	—	—	—	DTCE
ICU	DTCER129	—	—	—	—	—	—	—	DTCE
ICU	DTCER130	—	—	—	—	—	—	—	DTCE
ICU	DTCER131	—	—	—	—	—	—	—	DTCE
ICU	DTCER132	—	—	—	—	—	—	—	DTCE
ICU	DTCER134	—	—	—	—	—	—	—	DTCE
ICU	DTCER135	—	—	—	—	—	—	—	DTCE
ICU	DTCER136	—	—	—	—	—	—	—	DTCE
ICU	DTCER137	—	—	—	—	—	—	—	DTCE
ICU	DTCER138	—	—	—	—	—	—	—	DTCE
ICU	DTCER139	—	—	—	—	—	—	—	DTCE
ICU	DTCER140	—	—	—	—	—	—	—	DTCE
ICU	DTCER141	—	—	—	—	—	—	—	DTCE
ICU	DTCER142	—	—	—	—	—	—	—	DTCE
ICU	DTCER143	—	—	—	—	—	—	—	DTCE
ICU	DTCER144	—	—	—	—	—	—	—	DTCE
ICU	DTCER145	—	—	—	—	—	—	—	DTCE
ICU	DTCER149	—	—	—	—	—	—	—	DTCE
ICU	DTCER150	—	—	—	—	—	—	—	DTCE
ICU	DTCER151	—	—	—	—	—	—	—	DTCE
ICU	DTCER152	—	—	—	—	—	—	—	DTCE
ICU	DTCER153	—	—	—	—	—	—	—	DTCE
ICU	DTCER174	—	—	—	—	—	—	—	DTCE
ICU	DTCER175	—	—	—	—	—	—	—	DTCE
ICU	DTCER176	—	—	—	—	—	—	—	DTCE
ICU	DTCER177	—	—	—	—	—	—	—	DTCE
ICU	DTCER178	—	—	—	—	—	—	—	DTCE
ICU	DTCER179	—	—	—	—	—	—	—	DTCE

Table 4.2 List of I/O Registers (Bit Order) (7 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
ICU	DTCER180	—	—	—	—	—	—	—	DTCE
ICU	DTCER181	—	—	—	—	—	—	—	DTCE
ICU	DTCER182	—	—	—	—	—	—	—	DTCE
ICU	DTCER183	—	—	—	—	—	—	—	DTCE
ICU	DTCER184	—	—	—	—	—	—	—	DTCE
ICU	DTCER186	—	—	—	—	—	—	—	DTCE
ICU	DTCER187	—	—	—	—	—	—	—	DTCE
ICU	DTCER188	—	—	—	—	—	—	—	DTCE
ICU	DTCER189	—	—	—	—	—	—	—	DTCE
ICU	DTCER190	—	—	—	—	—	—	—	DTCE
ICU	DTCER192	—	—	—	—	—	—	—	DTCE
ICU	DTCER193	—	—	—	—	—	—	—	DTCE
ICU	DTCER194	—	—	—	—	—	—	—	DTCE
ICU	DTCER195	—	—	—	—	—	—	—	DTCE
ICU	DTCER196	—	—	—	—	—	—	—	DTCE
ICU	DTCER215	—	—	—	—	—	—	—	DTCE
ICU	DTCER216	—	—	—	—	—	—	—	DTCE
ICU	DTCER219	—	—	—	—	—	—	—	DTCE
ICU	DTCER220	—	—	—	—	—	—	—	DTCE
ICU	DTCER223	—	—	—	—	—	—	—	DTCE
ICU	DTCER224	—	—	—	—	—	—	—	DTCE
ICU	DTCER247	—	—	—	—	—	—	—	DTCE
ICU	DTCER248	—	—	—	—	—	—	—	DTCE
ICU	DTCER254	—	—	—	—	—	—	—	DTCE
ICU	IER02	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER03	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER05	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER07	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER08	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0C	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0D	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0E	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER0F	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER10	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER11	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER12	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER13	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER15	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER16	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER17	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER18	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1A	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1B	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1C	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1E	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	IER1F	IEN7	IEN6	IEN5	IEN4	IEN3	IEN2	IEN1	IEN0
ICU	SWINTR	—	—	—	—	—	—	—	SWINT
ICU	FIR	FIEN	—	—	—	—	—	—	—
FVCT[7:0]									
ICU	IPR00	—	—	—	—	—	—	IPR[3:0]	—
ICU	IPR01	—	—	—	—	—	—	IPR[3:0]	—
ICU	IPR02	—	—	—	—	—	—	IPR[3:0]	—

Table 4.2 List of I/O Registers (Bit Order) (12 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
RSPi0	SSLP	—	—	—	—	SSLP3	SSLP2	SSLP1	SSLP0
RSPi0	SPPCR	—	—	MOIFE	MOIFV	—	—	SPLP2	SPLP
RSPi0	SPSR	SPRF	—	SPTEF	—	PERF	MODF	IDLNF	OVRF
RSPi0	SPDR	H[15:0]							
		H[15:0]							
		L[15:0]							
		L[15:0]							
RSPi0	SPSCR	—	—	—	—	—	—	SPSLN[2:0]	—
RSPi0	SPSSR	—	—	SPECM[2:0]	—	—	—	SPCP[2:0]	—
RSPi0	SPBR	SPR7	SPR6	SPR5	SPR4	SPR3	SPR2	SPR1	SPR0
RSPi0	SPDCR	—	—	SPLW	SPRDTD	SLSEL[1:0]	—	SPFC[1:0]	—
RSPi0	SPCKD	—	—	—	—	—	—	SCKDL[2:0]	—
RSPi0	SSLND	—	—	—	—	—	—	SLNDL[2:0]	—
RSPi0	SPND	—	—	—	—	—	—	SPNDL[2:0]	—
RSPi0	SPCR2	—	—	—	—	PTE	SPIIE	SPOE	SPPE
RSPi0	SPCMD0	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
RSPi0	SPCMD1	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
RSPi0	SPCMD2	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
RSPi0	SPCMD3	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
RSPi0	SPCMD4	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
RSPi0	SPCMD5	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
RSPi0	SPCMD6	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
RSPi0	SPCMD7	SCKDEN	SLNDEN	SPNDEN	LSBF	—	—	SPB[3:0]	—
		SSLKP	—	SSLA[2:0]	—	BRDV[1:0]	—	CPOL	CPHA
S12AD0	ADCSR	ADST	ADCS[1:0]	—	ADIE	—	CKS[1:0]	TRGE	EXTRG
S12AD0	ADANS	—	—	CH[1:0]	—	—	PG002SEL	PG001SEL	PG000SEL
		—	—	—	—	—	PG002EN	PG001EN	PG000EN
S12AD0	ADPG	—	—	—	—	—	PG002GAIN[3:0]	PG001GAIN[3:0]	PG000GAIN[3:0]
		—	—	—	—	—	PG002GAIN[3:0]	PG001GAIN[3:0]	PG000GAIN[3:0]
S12AD0	ADCER	ADRFMT	—	ADIEW	ADIE2	DIAGM	DIAGLD	DIAGVAL[1:0]	—
		—	—	ACE	—	—	ADPRC[1:0]	SHBYP	—
S12AD0	ADSTRGR	—	—	—	—	—	ADSTRS1[4:0]	—	—
		—	—	—	—	—	ADSTRS0[4:0]	—	—
S12AD	ADCMPMD0	—	—	CEN102[1:0]	—	CEN101[1:0]	—	CEN100[1:0]	—
		—	—	CEN002[1:0]	—	CEN001[1:0]	—	CEN000[1:0]	—
S12AD	ADCMPMD1	—	VSELL1	VSELH1	CSEL1	—	VSELL0	VSELH0	CSEL0
		—	—	REFH[2:0]	—	—	—	REFL[2:0]	—
S12AD	ADCMPNR0	—	—	—	—	—	C002NR[3:0]	—	—
		—	—	—	—	—	C001NR[3:0]	—	—
S12AD	ADCMPNR1	—	—	—	—	—	C102NR[3:0]	—	—
		—	—	—	—	—	C101NR[3:0]	—	—
S12AD	ADCMPFR	—	—	C102FLAG	C101FLAG	C100FLAG	C002FLAG	C001FLAG	C000FLAG
S12AD	ADCMPSEL	—	—	—	—	—	—	POERQ	IE
		—	—	SEL102	SEL101	SEL100	SEL002	SEL001	SEL000

Table 4.2 List of I/O Registers (Bit Order) (16 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
POE	POECR2	—	—	—	—	—	MTU3BDZE	MTU4ACZE	MTU4BDZE
		—	—	—	—	—	MTU6BDZE	MTU7ACZE	MTU7BDZE
POE	POECR3	—	—	—	—	—	—	GPT3ABZE	GPT2ABZE
		—	—	—	—	—	—	GPT1ABZE	GPT0ABZE
POE	POECR4	—	—	IC5ADDMT67 ZE	IC4ADDMT67 ZE	IC3ADDMT67 ZE	—	IC1ADDMT67 ZE	CMADDMT67 ZE
		—	—	IC5ADDMT34 ZE	IC4ADDMT34 ZE	IC3ADDMT34 ZE	IC2ADDMT34 ZE	—	CMADDMT34 ZE
POE	POECR5	—	—	—	—	—	—	—	—
		—	—	IC5ADDMT0Z E	IC4ADDMT0Z E	—	IC2ADDMT0Z E	IC1ADDMT0Z E	CMADDMT0Z E
POE	POECR6	—	—	—	IC4ADDGPT2 3ZE	IC3ADDGPT2 3ZE	IC2ADDGPT2 3ZE	IC1ADDGPT2 3ZE	CMADDGPT2 3ZE
		—	—	IC5ADDGPT0 1ZE	—	IC3ADDGPT0 1ZE	IC2ADDGPT0 1ZE	IC1ADDGPT0 1ZE	CMADDGPT0 1ZE
POE	ICSR4	—	—	—	POE10F	—	—	POE10E	PIE4
		—	—	—	—	—	—	POE10M[1:0]	
POE	ALR1	—	—	—	—	—	—	—	—
		OLSEN	—	OLSG2B	OLSG2A	OLSG1B	OLSG1A	OLSG0B	OLSG0A
POE	ICSR5	—	—	—	POE11F	—	—	POE11E	PIE5
		—	—	—	—	—	—	POE11M[1:0]	
CAN0*3	MB.ID	IDE	RTR	—	—	—	SID[10:0]		
		SID[10:0]				EID[17:0]			
		—				EID[17:0]			
		—				EID[17:0]			
	MB.DLC	—	—	—	—	—	—	—	—
		—	—	—	—	DLC[3:0]			
	MB.DATA 0 to 7								
CAN0*3	MKR0	—				SID[10:0]			
		SID[10:0]				EID[17:0]			
CAN0*3	MKR1	—				SID[10:0]			
		SID[10:0]				EID[17:0]			
		—				EID[17:0]			
		—				EID[17:0]			
CAN0*3	MKR2	—				SID[10:0]			
		SID[10:0]				EID[17:0]			
		—				EID[17:0]			
		—				EID[17:0]			
CAN0*3	MKR3	—				SID[10:0]			
		SID[10:0]				EID[17:0]			
		—				EID[17:0]			
		—				EID[17:0]			
CAN0*3	MKR4	—				SID[10:0]			
		SID[10:0]				EID[17:0]			
		—				EID[17:0]			
		—				EID[17:0]			

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Item		Symbol	Value	Unit
Power supply voltage		VCC PLLVCC	-0.3 to +6.5	V
Input voltage (except for ports 4 to 6)		V _{IN}	-0.3 to VCC+0.3	V
Input voltage (port 4)		V _{IN}	-0.3 to AVCC0+0.3	V
Input voltage (ports 5 and 6)		V _{IN}	-0.3 to AVCC+0.3	V
Analog power supply voltage		AVCC0, AVCC*1	-0.3 to +6.5	V
Reference power supply voltage		VREFH0*1	-0.3 to AVCC0+0.3	V
		VREF*1	-0.3 to AVCC+0.3	
Analog input voltage (port 4)		V _{AN}	-0.3 to AVCC0+0.3	V
Analog input voltage (ports 5 and 6)		V _{AN}	-0.3 to AVCC+0.3	V
Operating temperature	D version	T _{opr}	-40 to +85	°C
	G version	T _{opr}	-40 to +105	°C
Storage temperature		T _{stg}	-55 to +125	°C

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

Note 1. Do not leave the AVCC0, VREFH0, VREFL0, AVSS0, AVCC, VREF, and AVSS pins open circuit even if the A/D converter is not to be used.

- When the 12-bit converter is not in use:
Connect the AVCC0 pin to AVCC (or VCC for a 64-pin product), the VREFH0 pin to VREF (or AVCC or VCC for an 80- or 64-pin product, respectively), and the AVSS0 and VREFL0 pins to VSS.
- When the 10-bit converter is not in use:
Connect the AVCC pin to AVCC0, the VREF pin to VREFH0, and the AVSS pin to AVSS0.
- When neither the 10- nor the 12-bit converter is in use:
Connect the AVCC0, VREFH0, AVCC, and VREF pins to VCC, and the AVSS0, VREFL0, and AVSS pins to VSS.

Table 5.3 DC Characteristics (2)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Supply current ^{*1}	In operation	Max. ^{*2}	I _{CC} ^{*3}	-	-	70	mA	ICLK = 100 MHz PCLK = 50 MHz
		Normal ^{*4}		-	35	-		
		Increased by BGO operation ^{*5}		-	15	-		
	Sleep				22	60		
	All-module-clock-stop mode ^{*6}				14	28		
	Standby mode	Software standby mode		-	0.10	3	mA	
		Deep software standby mode	-	20	60	μA		
Analog power supply current	During 12-bit A/D conversion (when a sample-and-hold circuit is in use; per unit)		AI _{CC0}	-	3	5	mA	
	During 12-bit A/D conversion (when a sample-and-hold circuit is not in use; per unit)			-	3	5	mA	
	Programmable gain amp (per channel)			-	1	2	mA	
	Window comparator (1 channel)				0.5	1	mA	
	Window comparator (6 channels)			-	1	2	mA	
	During 12-bit A/D conversion (per unit)			-	60	90	μA	
	During 10-bit A/D conversion (per unit)		AI _{CC}	-	0.9	2	mA	
	Waiting for 10-bit A/D conversion (all units)			-	0.3	3	μA	
Reference power supply current	During 12-bit A/D conversion (per unit)		AI _{REFH0}	-	1.6	3	mA	
	Waiting for 12-bit A/D conversion (all units)			-	1.6	3	mA	
	During 10-bit A/D conversion (per unit)		AI _{REF}	-	0.1	1	mA	
	Waiting for 10-bit A/D conversion (all units)			-	0.1	3	μA	
VCC rising gradient			SV _{CC}	-	-	20	ms/V	

Note 1. Supply current values are with all output pins unloaded.

Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.

Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK: PCLK = 8:4)

$I_{CC} \text{ max.} = 0.54 \times f + 16 \text{ (max.)}$

$I_{CC} \text{ max.} = 0.3 \times f + 5 \text{ (normal operation)}$

$I_{CC} \text{ max.} = 0.44 \times f + 16 \text{ (sleep mode)}$

Note 4. Measured with clocks not supplied to the peripheral functions. This does not include the BGO operation.

Note 5. Incremented if data is written to or erased from the ROM or data flash for data storage during the program execution.

Note 6. The values are for reference.

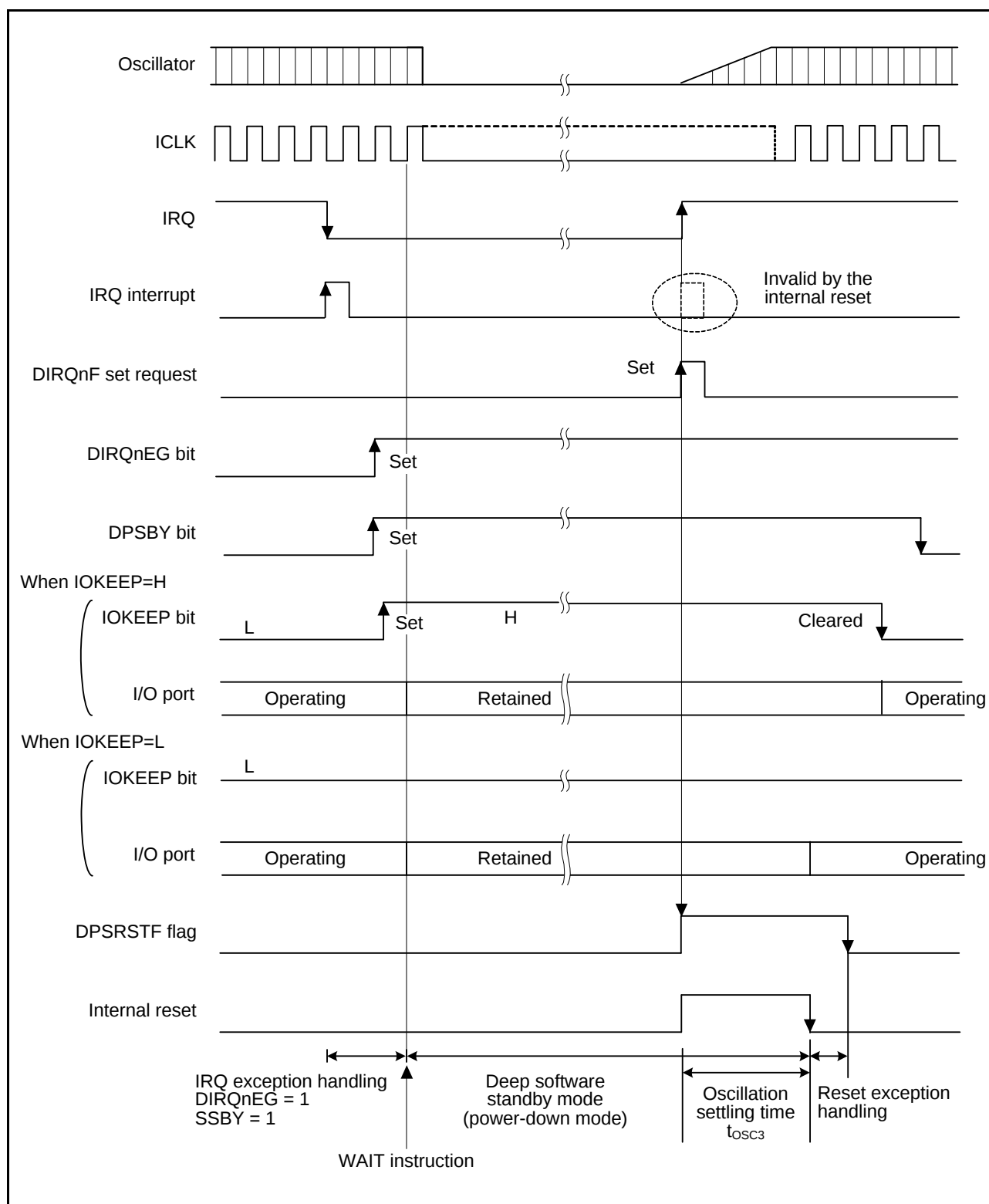


Figure 5.3 Oscillation Settling Timing after Deep Software Standby Mode

Table 5.11 Timing of On-Chip Peripheral Modules (3)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item			Symbol	Min.	Max.	Unit	Test Conditions	
RSPI	RSPCK clock cycle	Master	t _{SPcyc}	4	4096	t _{Pcyc}	Figure 5.11	
		Slave		8	4096			
	RSPCK clock high pulse width	Master	t _{SPCKWH}	(t _{SPcyc} - t _{SPCKR} - t _{SPCKF}) / 2-3	-	ns		
		Slave		(t _{SPcyc} - t _{SPCKR} - t _{SPCKF}) / 2	-			
	RSPCK clock low pulse width	Master	t _{SPCKWL}	(t _{SPcyc} - t _{SPCKR} - t _{SPCKF}) / 2-3	-	ns		
		Slave		(t _{SPcyc} - t _{SPCKR} - t _{SPCKF}) / 2	-			
	RSPCK clock rise/fall time	Output	t _{SPCKR}	-	5	ns		
		Input	t _{SPCKF}	-	1	μs		
	Data input setup time	Master	t _{SU}	25	-	ns	Figure 5.12 to Figure 5.15	
		Slave		0	-			
	Data input hold time	Master	t _H	0	-	ns		
		Slave		20+2×t _{Pcyc}	-			
	SSL setup time	Master	t _{LEAD}	1	8	t _{SPcyc}		
		Slave		4	-	t _{Pcyc}		
	SSL hold time	Master	t _{LAG}	1	8	t _{SPcyc}		
		Slave		4	-	t _{Pcyc}		
	Data output delay time	Master	t _{OD}	-	20	ns		
		Slave		-	3×t _{Pcyc} +40			
	Data output hold time	Master	t _{OH}	0	-	ns		
		Slave		0	-			
	Successive transmission delay time	Master	t _{TD}	t _{SPcyc} +2×t _{Pcyc}	8×t _{SPcyc} +2×t _{Pcyc}	ns		
		Slave		4×t _{Pcyc}	-			
	MOSI, MISO rise/fall time	Output	t _{DR}	-	15	ns	Figure 5.12 to Figure 5.15	
		Input	t _{DF}	-	1	μs		
	SSL rise/fall time	Output	t _{SSLR}	-	15	ns		
		Input	t _{SSLF}	-	1	μs		
	Slave access time			t _{SA}	-	4	t _{Pcyc}	Figure 5.12 to Figure 5.15
	Slave output release time			t _{REL}	-	3	t _{Pcyc}	

Note: • Note 1: t_{PCyc} : PCLK cycle

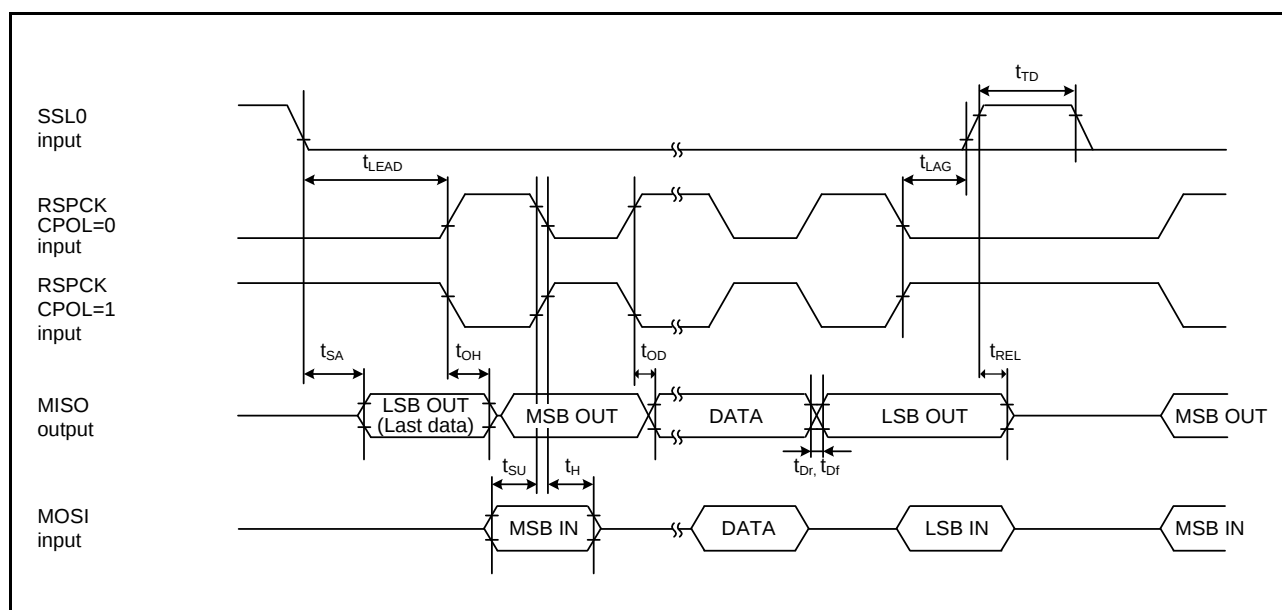


Figure 5.15 RSPI Timing (Slave, CPHA = 1)

Table 5.18 Comparator Characteristics

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V

AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V

AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V

AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Analog input capacitance	Cin	-	-	6	pF	
REFH pin offset voltage	Voff	-	-	5	mV	
REFL pin offset voltage		-	-	5	mV	
REFH input voltage range	Vin	1.7	-	AVcc – 0.3	V	
REFL input voltage range		0.3	-	AVcc – 1.7	V	
REFH reply time	tCR	-	-	1	μs	
REFL reply time	tCF	-	-	1	μs	

5.7 ROM (Flash Memory for Code Storage) Characteristics

Table 5.21 ROM (Flash Memory for Code Storage) Characteristics (1)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Temperature range for the programming/erasure operation:

Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Rewrite/erase cycle ^{*1}	N _{PEC}	1000	—	—	Times	
Data hold time	t _{DRP}	30 ^{*2}	—	—	Year	Ta = +85C°

Note 1. Definition of rewrite/erase cycle:

The rewrite/erase cycle is the number of erasing for each block. When the rewrite/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 256-byte writing is performed 16 times for different addresses in 4-Kbyte block and then the entire block is erased, the rewrite/erase cycle is counted as one. However, writing to the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. The value is obtained from the reliability test.

Table 5.22 ROM (Flash Memory for Code Storage) Characteristics (2)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Temperature range for the programming/erasure operation:

Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Programming time	256 bytes	t _{P256}	—	2	ms	PCLK = 50 MHz N _{PEC} ≤ 100
	4 Kbytes	t _{P4K}	—	23	ms	
	16 Kbytes	t _{P16K}	—	90	ms	
	256 byte	t _{P256}	—	2.4	ms	PCLK = 50 MHz N _{PEC} > 100
	4 Kbytes	t _{P4K}	—	27.6	ms	
	16 Kbytes	t _{P16K}	—	108	ms	
Erasure time	4 Kbytes	t _{E4K}	—	25	ms	PCLK = 50 MHz N _{PEC} ≤ 100
	16 Kbytes	t _{E16K}	—	100	ms	
	4 Kbytes	t _{E4K}	—	30	ms	PCLK = 50 MHz N _{PEC} > 100
	16 Kbytes	t _{E16K}	—	120	ms	
Suspend delay time during writing	t _{SPD}	—	—	120	μs	Figure 5.24 PCLK = 50 MHz
First suspend delay time during erasing (in suspend priority mode)	t _{SESD1}	—	—	120	μs	
Second suspend delay time during erasing (in suspend priority mode)	t _{SESD2}	—	—	1.7	ms	
Suspend delay time during erasing (in erasure priority mode)	t _{SEED}	—	—	1.7	ms	

5.8 Data Flash (Flash Memory for Data Storage) Characteristics

Table 5.23 Data Flash (Flash Memory for Data Storage) Characteristics (1)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Temperature range for the programming/erasure operation:
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Rewrite/erase cycle ^{*1}	N _{DPEC}	30000	—	—	Times	
Data hold time	t _{DDRP}	30 ^{*2}	—	—	Year	Ta = +85C°

Note 1. Definition of rewrite/erase cycle:

The rewrite/erase cycle is the number of erasing for each block. When the rewrite/erase cycle is n times (n = 30000), erasing can be performed n times for each block. For instance, when 128-byte writing is performed 16 times for different addresses in 2-Kbyte block and then the entire block is erased, the rewrite/erase cycle is counted as one. However, writing to the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. The value is obtained from the reliability test.

Table 5.24 Data Flash (Flash Memory for Data Storage) Characteristics (2)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Temperature range for the programming/erasure operation:
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Programming time	8 bytes	t _{DP8}	—	0.4	2	ms	PCLK = 50 MHz
	128 bytes	t _{DP128}	—	1	5	ms	
Erase time	2 Kbytes	t _{DE2K}	—	70	250	ms	PCLK = 50 MHz
Blank check time	8 bytes	t _{DBC8}	—	—	30	μs	PCLK = 50 MHz
	2 Kbytes	t _{DBC2K}	—	—	0.7	ms	
Suspend delay time during writing		t _{DSPD}	—	—	120	μs	Figure 5.24 PCLK = 50 MHz
First suspend delay time during erasing (in suspend priority mode)		t _{DSESD1}	—	—	120	μs	
Second suspend delay time during erasing (in suspend priority mode)		t _{DSESD2}	—	—	1.7	ms	
Suspend delay time during erasing (in erasure priority mode)		t _{DSEED}	—	—	1.7	ms	

Appendix 1.Package Dimensions

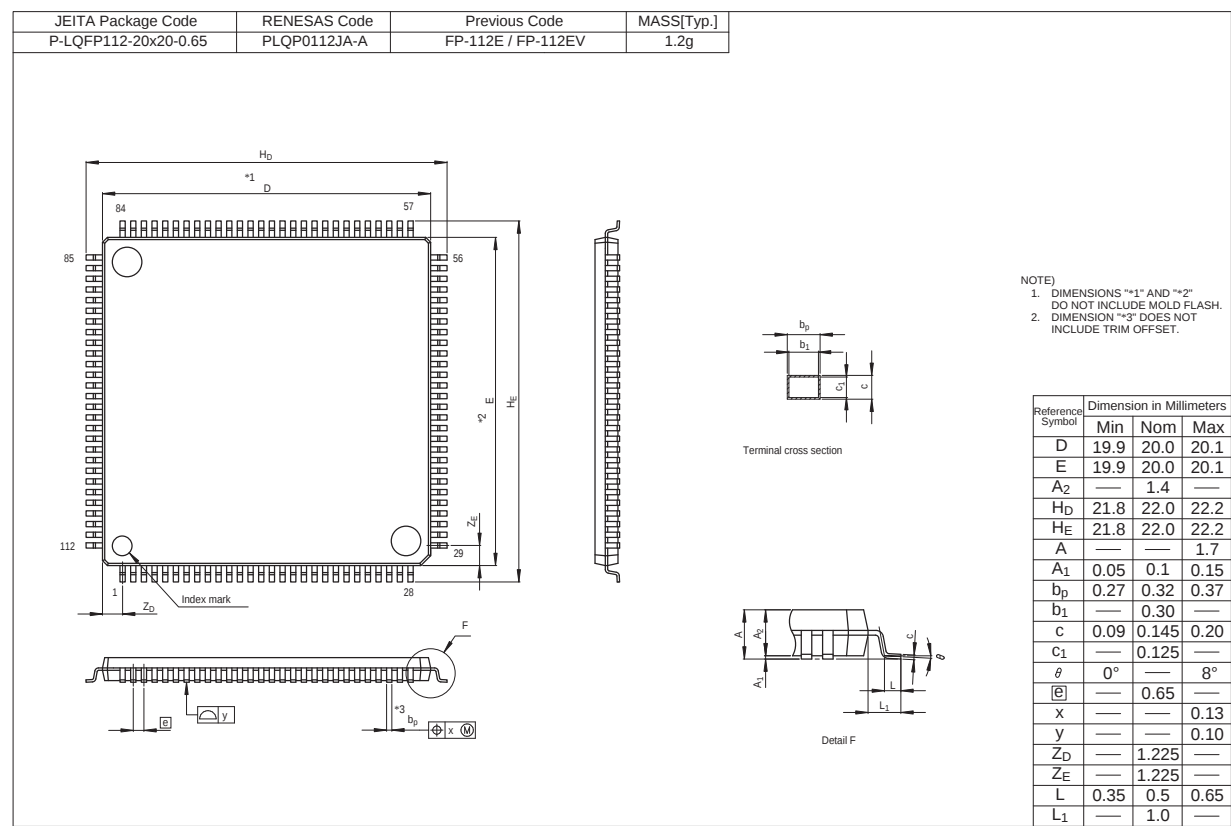


Figure A 112-Pin LQFP (PLQP0112JA-A) Package Dimensions

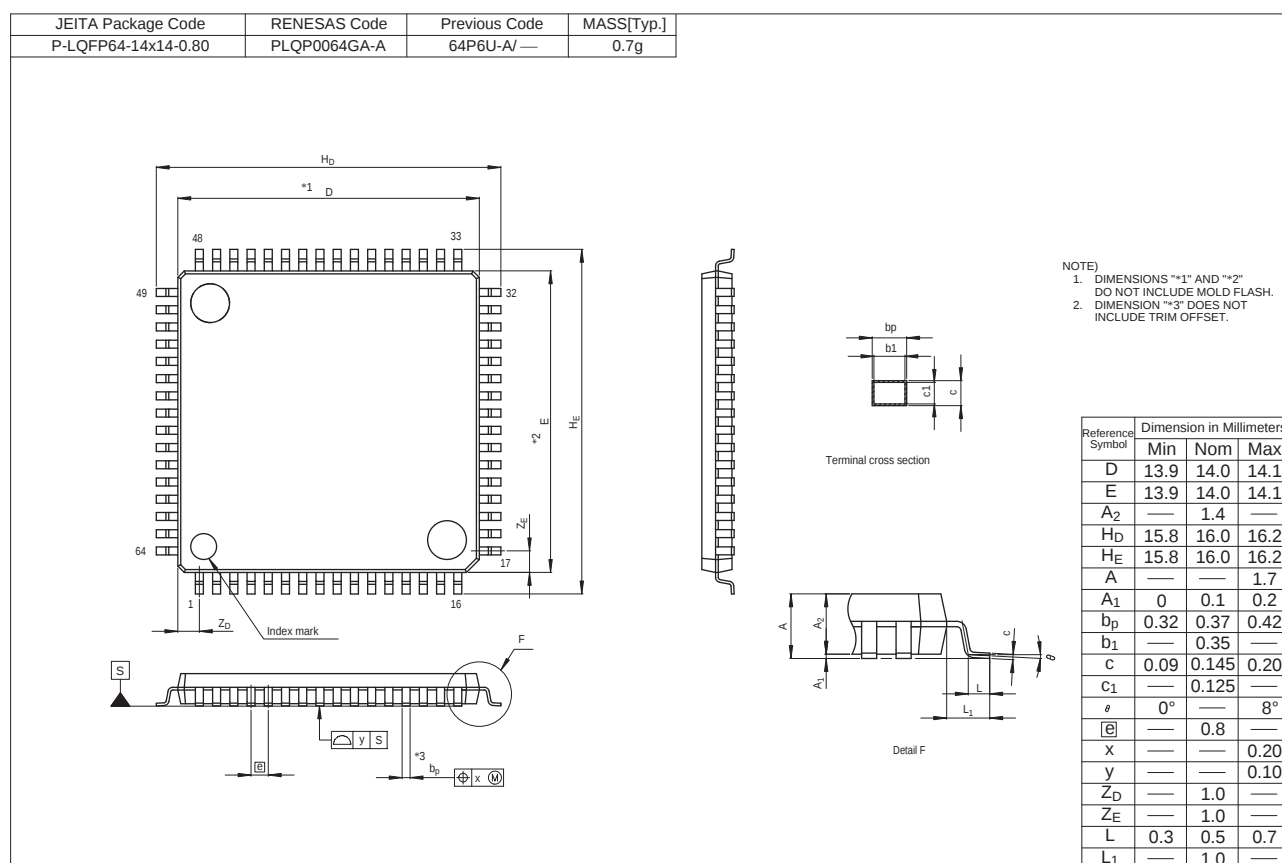


Figure E 64-Pin LQFP (PLQP0064GA-A) Package Dimensions